

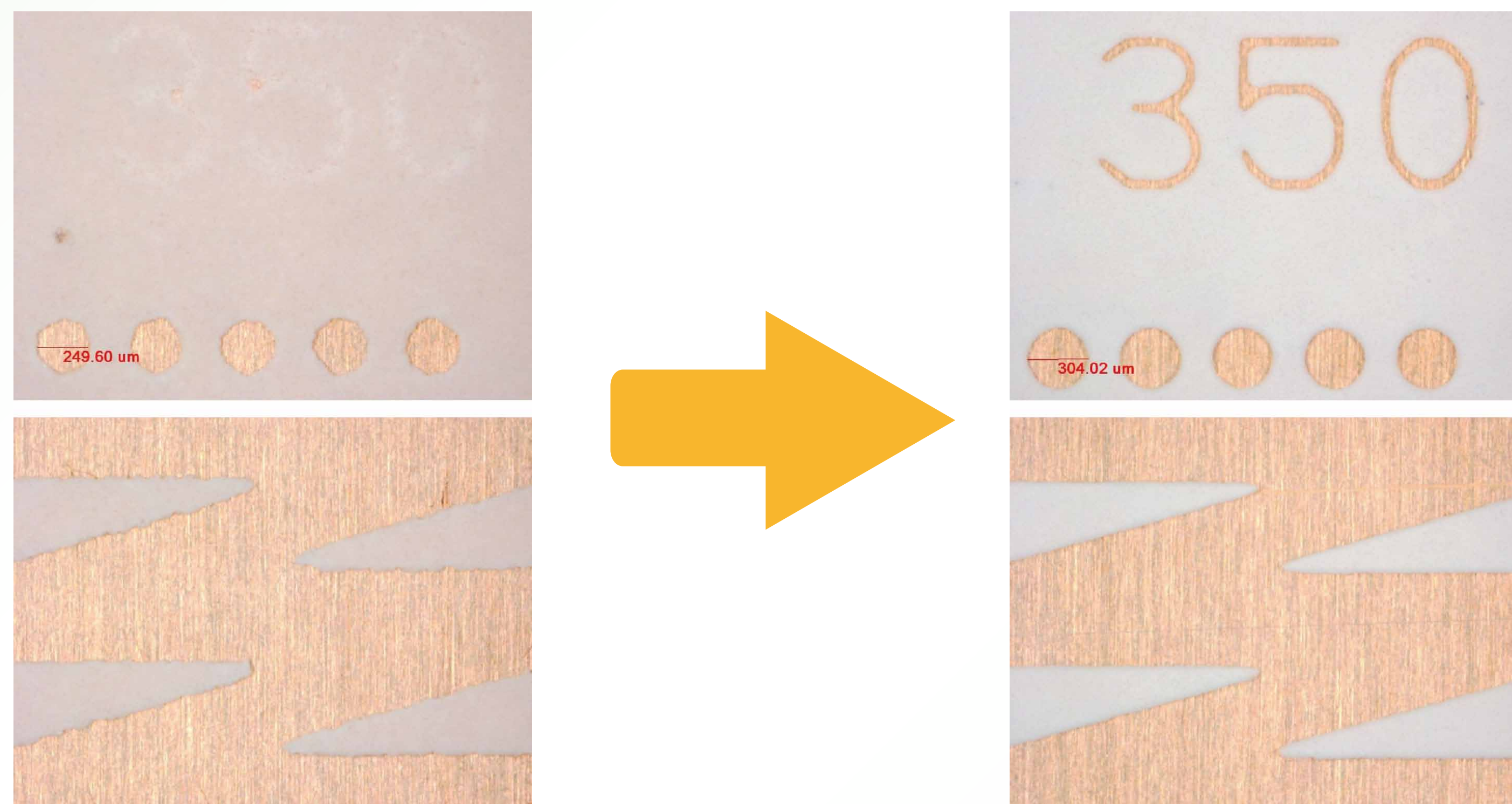


# PSR<sup>®</sup>-4000 HS Series

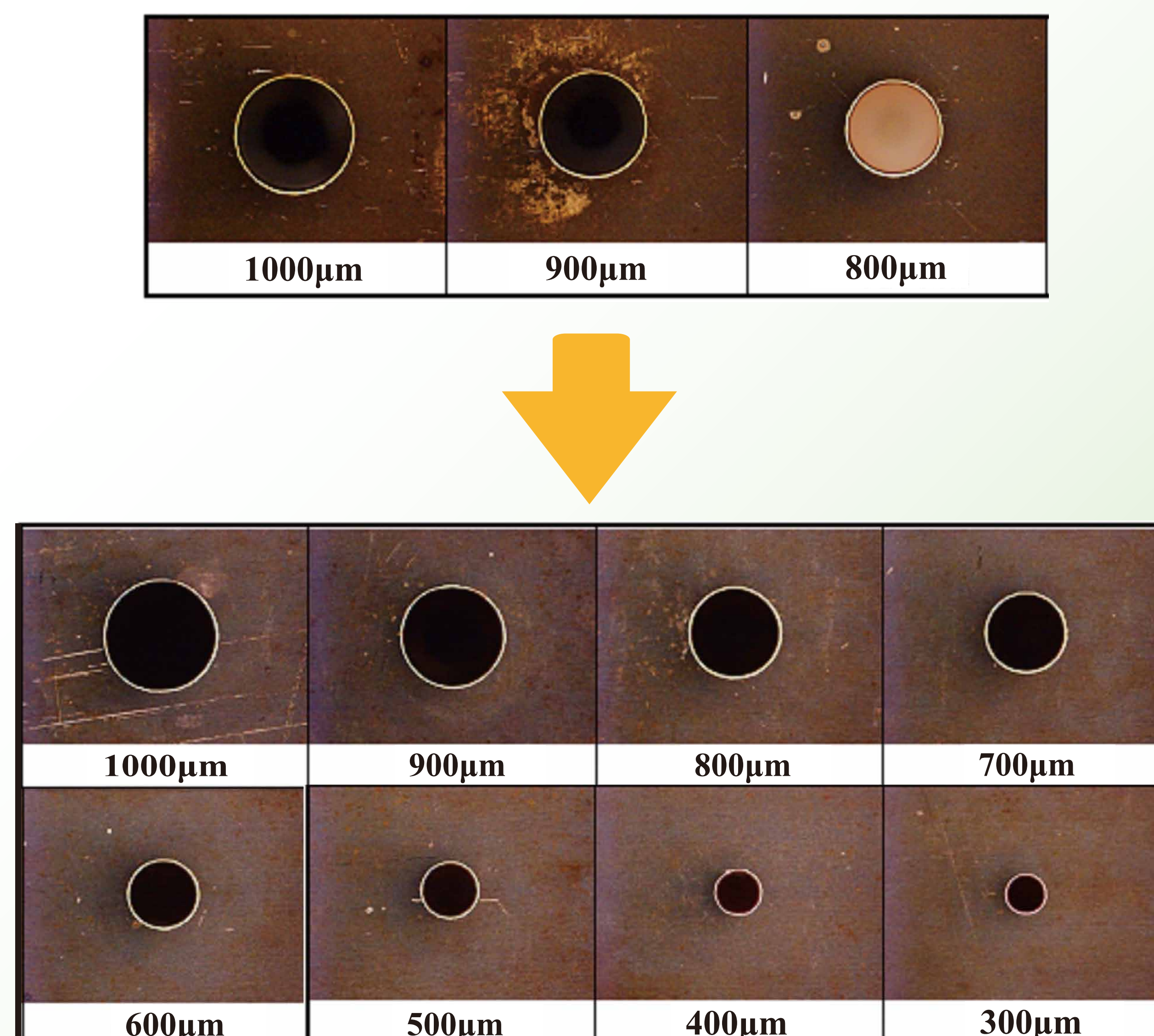
## 放熱対策現像型ソルダーレジスト Heat-Spread Photoimageable Solder Resist

- **熱伝導率が一般のソルダーレジストの約 10 倍**  
Thermal conductivity: app.10 times higher (compared with general solder resist)
- **プリント配線板による放熱が可能**      Heat spread function by PCB itself
- **一般のソルダーレジストと同じ工程で使用可能**  
Same process as general solder resist

従来の問題点を改良した新規開発品：解像性・ハレーションを向上  
Modified ink improved conventional problems : Upgrade resolution and halation



スルホール内の現像性が向上    Better developability inside PTH



反射率が向上し、LED 実装基板に対応    Y値 :55→71  
Higher reflection for LED application (Y-value 55→71)